

TAI-SAW TECHNOLOGY CO., LTD.

No. 3, Industrial 2nd Rd., Ping-Chen Industrial District, Taoyuan, 324, Taiwan, R.O.C. TEL: 886-3-4690038 FAX: 886-3-4697532

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Product Specifications Approval Sheet

Product Description: Multi-layer Filter 5550MHz Size 1.6X0.8mm (BW 800MHz)					
TST Part No	.: TL0046AA0092				
Customer Pa	art No.:				
	Customer signature requ	ired			
	Company:				
	Division:				
	Approved by :				
	Approved by :				
Che	ecked by:	Nina Chen	Nina Chen Kosuma Jee		
Approved by:		Kazuma Lee	Kasuma Jee		
Dat	e:	2023/02/06			

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the change



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Multi-layer Filter 5550MHz Size 1.6X0.8mm (BW 800MHz)

MODEL NO.:TL0046AA0092 REV.2

A. MAXIMUM RATING:

1. Input Power: 2W

2. Operating temperature range: -40°C to +85°C

3. Storage temperature range: -40 °C to +85 °C

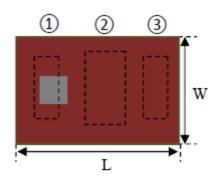
4. Moisture Sensitive Level: Level 1



B. ELECTRICAL CHARACTERISTICS:

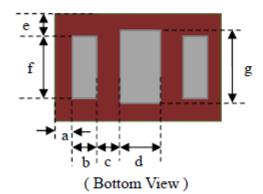
Item	Specifications		
Frequency range 頻率範圍	5150 ~ 5950 MHz		
Insertion Loss 插入衰耗	≤ 0.9dB (25 °C) ≤1.05 dB (-40~105 °C)		
Return Loss 回波損耗	≥ 10dB		
In/Output Impedance 輸入/輸出阻抗	50Ω		
	≥ 40dB (30 ~ 2700 MHz)		
	\geq 35dB (3400 ~ 3800 MHz)		
Attenuation 阻帶衰耗	≥ 20dB (@6900 MHz)		
	≥ 18dB (7250 ~ 7800 MHz)		
	≥ 20dB (10300 ~ 11700 MHz)		
Operation Temperature Range 溫度范圍	-40℃ ~ 85℃		
Permissible 輸入功率 (MAX) Input Power	2W		

C. <u>DIMENSION:</u>



Number	Terminal Name		
1	INPUT		
2	GND		
3	OUTPUT		

(Top View)





(Side View)

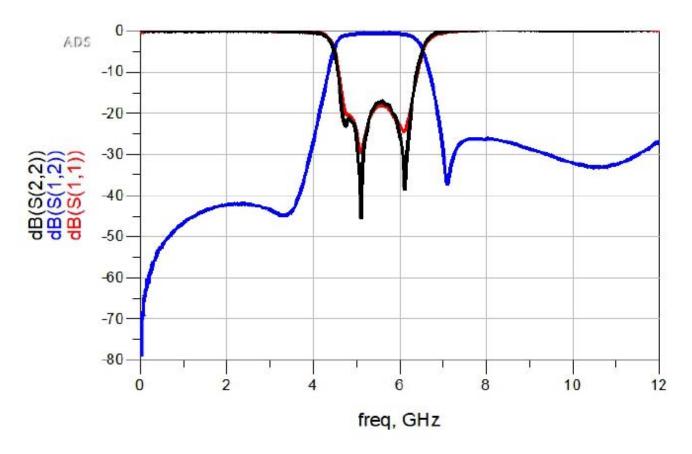


(Side View)

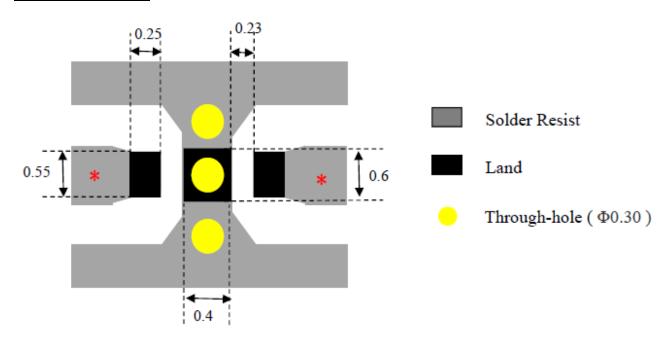
(Unit: mm)

Symbols	L	w	Т	a	b	с	d	е	f	g
Dimension	1.6+/-	0.8+/-	0.6+/-	0.12+/-	0.25+/-	0.23+/-	0.4+/-	0.125+/-	0.55+/-	0.6+/-
s	0.1	0.1	0.1	0.1	0.1	0.1	0.1	0.1	0.1	0.1

D. FREQUENCY CHARACTERISTICS:



E. PCB FOOTPRINT:

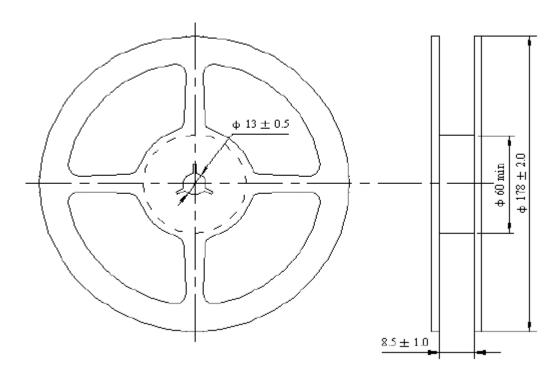


*Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness

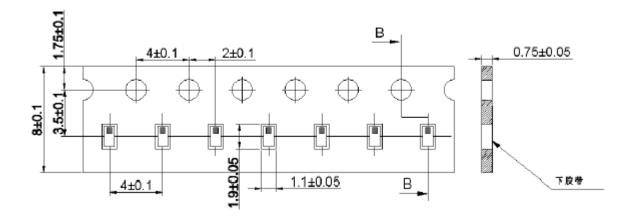
F. PACKING:

1. REEL DIMENSION:

(6000 pcs/Reel)



2. TAPE DIMENSION:



G.Reliability Test:

Vibration Resist

The device should fulfill the electrical specification after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in X , Y and Z directions.

Drop Shock

The device should have no mechanical damage after dropping onto the hard wooden board from the height of 100cm for 3 times each facet of the 3 dimensions of the device.

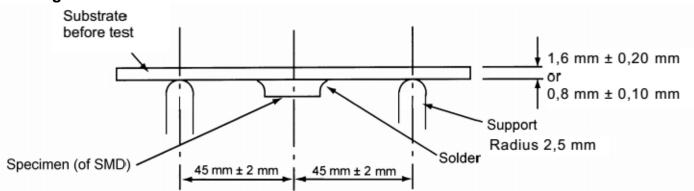
Solder Heat Proof

The device should be satisfied after preheating at $120^\circ \text{C} \sim 150^\circ \text{C}$ for 120 seconds and dipping in soldering Sn at $255^\circ \text{C} + 10^\circ \text{C}$ for 5 ± 0.5 seconds , or electric iron $300^\circ \text{C} - 10^\circ \text{C}$ for 3 ± 0.5 seconds , without damnify.

Adhesive Strength of Termination

The device have no remarkable damage or removal of the termination after horizontal force of $5N(\le 0603)$; 10N(>0603)with 10 ± 1 seconds.

Bending Resist Test



Weld the product to the center part of the PCB with the thickness 1.6 ± 0.2 mm or 0.8 ± 0.1 mm as the illustration shows, and keep exerting force arrow-ward on it at speed of :1mm/S , and hold for 5 ± 1 S at the position of 1.5mm bending distance , so far , any peeling off of the product metal coating should not be detected .

Moisture Proof

The device should fulfill the electrical specification after exposed to the temperature $60\pm2^{\circ}$ C and the relative humidity $90\sim95\%$ RH for 96 hours and $1\sim2$ hours recovery time under normal condition.

High Temperature Endurance

The device should fulfill the electrical specification after exposed to temperature 85±5°C for 96±2 hours and 1~2 hours recovery time under normal temperature.

Low Temperature Endurance

The device should fulfill the electrical specification after exposed to the temperature -40 $^{\circ}$ C ±5 $^{\circ}$ C for 96±2 hours and to 2 hours recovery time under normal temperature.

Temperature Cycle Test

The device should fulfill the electrical specification after exposed to the low temperature -40 $^{\circ}$ C and high temperature +85 $^{\circ}$ C for 30 $^{\pm}$ 2 min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

H. RECOMMENDED REFLOW PROFILE:

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (20~40sec).
- 4. Time: 2 times.

